Hong Kong Exchanges and Clearing Limited and The Stock Exchange of Hong Kong Limited take no responsibility for the contents of this announcement, make no representation as to its accuracy or completeness and expressly disclaim any liability whatsoever for any loss howsoever arising from or in reliance upon the whole or any part of the contents of this announcement.

This announcement is for information purposes only and does not constitute an invitation or an offer to acquire, purchase or subscribe for securities.

This announcement does not constitute or form a part of any offer or solicitation to purchase or subscribe for securities in the United States. The securities referred to herein have not been and will not be registered under the United States Securities Act of 1933, as amended (the "Securities Act"), or the securities laws of any other jurisdiction and may not be offered or sold within the United States (as defined in Regulation S under the Securities Act ("Regulation S")), except pursuant to an exemption from, or in a transaction not subject to, the registration requirements of the Securities Act. Accordingly, such securities will be offered and sold outside the United States in compliance with Regulation S.

NOTICE OF LISTING ON THE STOCK EXCHANGE OF HONG KONG LIMITED



JINAN HI-TECH HOLDING GROUP CO., LTD.

(濟南高新控股集團有限公司) (the "Issuer")

U.S.\$250,000,000 6.40 per cent. Bonds due 2021 (the "Bonds") (Stock Code: 5481)

Joint Global Coordinators

China International Capital Corporation		Industrial Bank Co., Ltd. Zho Hong Kong Branch Intern			Guotai Junan International
	Joint	Bookrunners and Join	t Lead Mana	gers	
China International Capital Corporation		rial Bank Co., Ltd. ng Kong Branch	Zhongtai International		Guotai Junan International
Silk Road International		Shanghai Pudong Development Bank Hong Kong Branch		Central Wealth Securities Investment Limited	
China Everbright Bank Hong		Southwest Securities		BOCOM International	

International

Kong Branch

Application has been made to The Stock Exchange of Hong Kong Limited for the listing of, and permission to deal in, the Bonds as described in the Offering Circular dated 6 December 2018 by way of debt issues to professional investors (as defined in Chapter 37 of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited and in the Securities and Futures Ordinance (Chapter 571 of the Laws of Hong Kong)) only. Such listing and permission to deal in the Bonds is expected to become effective on or about 14 December 2018.

Hong Kong, 13 December 2018

As at the date of this announcement, the board of directors of the Issuer comprises seven directors, namely Li Hao, Wang Geng, Yang Wenming, Han Qiang, Feng Demin, Liu Jinhui and Xu Yi.